

# NOT RECOMMENDED FOR NEW DESIGN USE AL6562A



AL6562

#### TRANSITION MODE PFC LED CONTROLLER

### **Description**

The AL6562 is a current mode Power Factor Correction Controller and is designed for operating in Transition Mode. With a superior linear performance multiplier, it ensures the device operates over a wide input voltage range with superior THD (Total Harmonics Distortion). The output voltage is controlled by means of an error amplifier and a precise (1% @  $T_J = +25$ °C) internal voltage reference.

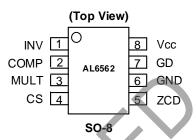
The AL6562 is designed to meet stringent energy-saving standards with low start-up current, and can operate with low current consumption when entering stand-by mode.

OVP circuitry increases system robustness, allowing the device to withstand transient caused at start-up and during load-disconnects.

### **Features**

- Single Stage Fly-Back PFC Controller
- Transition Mode Operation
- · Low Start-Up, Operating and Quiescent Currents
- Internal Start-Up Timer
- Enable/Disable Function on INV Input
- Totem Pole, Push-Pull Output Drive
- Adjustable Output Overvoltage Protection
- SO-8: Available in "Green" Molding Compound (No Br, Sb)
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please <u>contact us</u> or your local Diodes representative. <a href="https://www.diodes.com/quality/product-definitions/">https://www.diodes.com/quality/product-definitions/</a>

### **Pin Assignments**



# **Applications**

- Electronic Single-Stage LED Driver
- PFC Pre-Regulators to meet IEC61000-3-2
- High-End AC-DC Adaptor / Charger

#### Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

# **Typical Applications Circuit**

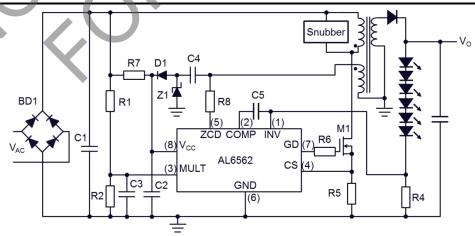


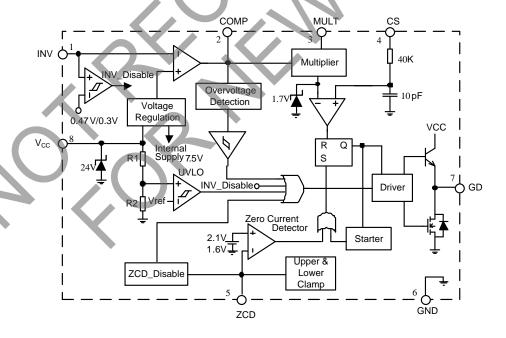
Figure 1. High Power Factor Non-Isolated Constant-Current LED Driver



# **Pin Descriptions**

Pin Number	Pin Name	Brief Description
1 INV		Inverting Input Pin of the Internal Error Amplifier
		This pin is connected externally via a resistor divider from the regulated output voltage. It can provide input to inverting input of internal error amplifier. This pin can also be used as ENABLE/DISABLE control input.
		Output from Error Amplifier
2	COMP	A feedback compensation network consisting of resistor and capacitor connects between INV (Pin1) and this pin to reduce the bandwidth and achieve stability of the voltage control loop and ensure high power factor and low THD.
		Input to the Internal Multiplier
3	MULT	This pin connects to the rectified mains voltage through external resistor divider to provide a sinusoidal voltage reference for the control current loop.
		Current Sense Connecting to External Resistor for Current Feedback
4 CS		The current flowing in the MOSFET is sensed through a resistor, the resulting voltage is applied to this pin and compared with an internal sinusoidal-shaped reference generated by the multiplier to determine MOSFET's turn-off. This pin has an internal Leading-Edge-Blanking of about 200 nanoseconds to improve
		noise immunity.
		Zero Current Detection
5	ZCD	This pin takes input from inductor's demagnetization sensing to achieve zero current detection, required for Transition Mode (TM) operation. A negative-going edge triggers turn-on of MOSFET.
6	GND	System Ground
U	GND	Ground for circuit. Current return for both the signal circuitry and the gate drive stage.
		Gate Driver Output
		This pin is able to drive external MOSFET. The totem-pole output stage is able to drive MOSFET with a
7	GD	peak current of 600mA/800mA for source and sink capability respectively. The high level voltage of this pin
		is internally clamped at about 12V to avoid excessive gate voltage in case Vcc pin is supplied by a higher
		voltage.
		System Power Input Pin This pin is far sumply voltage of both the simply part and got ordinary of the IC. Hence limit is extended to a
8	Vcc	This pin is for supply voltage of both the signal part and gate driver of the IC. Upper limit is extended to a maximum of 22V to provide more headroom for supply voltage changes. This pin has an internal 25V Zener
		to protect the IC itself from overvoltage transients.

# **Functional Block Diagram**





# **Absolute Maximum Ratings** (Note 4)

Symbol	Description	Value	Unit
Vcc	IC Supply Voltage	Self Limited	V
Icc	Operating Supply Current	30	mA
VINV, VCOMP, VMULT	Input/Output of Error Amplifier, Input of Multiplier	-0.3 to 7	V
Izcd (Note 5)	Zero Current Detector Max. Current	Source: -50 Sink: 10	mA mA
ESD(HBM)	ESD (Human Body Model)	3000	V
ESD(MM)	ESD (Machine Model)	200	V
TJ	Junction Temperature Range	-40 to +150	°C
Tstg	Storage Temperature Range	-65 to +150	°C
Ртот	Power Dissipation	0.65	W
Reja	Thermal Resistance (Junction – Ambient)	150	°C/W
TLEAD	Lead Temperature (Soldering, 10s)	+260	°C

Notes: 4. Stresses greater than the Absolute Maximum Ratings specified above, can cause permanent damage to the device. These are stress ratings only; functional operation of the device at these or any other conditions exceeding those indicated in this specification is not implied. Device reliability can be affected by exposure to absolute maximum rating conditions for extended periods of time.

5. Currents flowing into device pins are considered as positive and out of device pins are considered as negative.





# **Electrical Characteristics**

(Over recommended operating conditions unless otherwise specified V<sub>CC</sub> = 12.0V, T<sub>J</sub> = -25°C to +125°C, C<sub>O</sub> = 1nF.)

Symbol	ended operating conditions unless otherwise  Parameter	Conditions	Min	Тур	Max	Unit
SUPPLY VOL		Conditions	141111	iyp	IVIGA	Oint
	IC Supply Voltage	After turn-on	10.3		22	V
Vcc Vcc on	Turn-On Threshold	Alter turn-on	11.0	12.0	13.0	V
	Turn-Off Threshold		8.7	9.5	10.3	V
Vcc off						V
Vcc-HYS	Hysteresis		2.2	2.5	2.8	-
Vz	Zener Voltage	Icc = 20mA	22	24		V
SUPPLY CUF		T =				
Istart-up	Start-Up Current	Before turn-on, V <sub>CC</sub> = 11V		40	70	μΑ
lq	Quiescent Current	After turn-on		2.5	3.75	mA
Icc	Operating Supply Current	@ 70kHz In OVP condition, V <sub>INV</sub> = 2.7V		3.5 1.4	5 2.2	mA mA
		Vzcp≤150mV, Vcc>Vcc-off		1.7	2.2	mA
lq	Quiescent Current	Vzcb≤150mV, Vcc <vcc-off< td=""><td>20</td><td>50</td><td>90</td><td>mA</td></vcc-off<>	20	50	90	mA
ERROR AMP	I IFIFR	VZCD < 130111V, VCC VCC-OFF		- 00		1107
-ARCH ARI		T <sub>J</sub> = +25°C	2.465	2.5	2.535	
VINV	Voltage Feedback Input Threshold	10.3V < Vcc < 22V	2.465	2.3	2.55	V
		Vcc = 10.3V to 22V	2.44	-		
_	Line Regulation	(Note 6)		2	5	mV
linv	Input Bias Current	V <sub>INV</sub> = 0 to 3V	-	-0.1	-1	μΑ
Gv	Voltage Gain	OPEN LOOP	60	80	_	dB
GB	Gain-Bandwidth	_	<del>-</del> -	1	_	MHz
	Source Current	$V_{COMP} = 4V$ , $V_{INV} = 2.4V$	-2	-4.0	-8	mA
Ісомр	Sink Current	$V_{COMP} = 4V$ , $V_{INV} = 2.6V$	2.5	4.5	_	mA
	Upper Clamp Voltage	ISOURCE = 0.5mA	<u> </u>	5.8		V
VCOMP	Lower Clamp Voltage	Isink = 0.5mA (Note 6)	2.1	2.25	2.4	V
VINVdis	Disable Threshold	ISINK - O.SITIA (NOTE 0)	250	300	350	mV
VINVen	Restart Threshold	1	400	470	540	mV
MULTIPLIER			400	470	340	IIIV
			0.2	0 25	I	V
VMULT	Linear Operation Range		0 - 3	0 – 3.5	_	V
ΔVcs	Output Maximum Slope	$V_{MULT} = 0 \text{ to } 0.5V,$	1.65	1.9	_	V/V
ΔV <sub>MULT</sub>	Gain (Note 7)	VCOMP = upper clamp	0.6	0.75	0.0	1/V
		VMULT = 1V, VCOMP = 4V	0.6	0.75	0.9	1/ V
	ENT DETECTOR		1 4 7	I 50	0.4	
Vzcdh	Upper Clamp Voltage	Izcp = 3mA	4.7	5.2	6.1	V
Vzcdl	Lower Clamp Voltage	Izcp = -3mA	0.3	0.65	1.0	V
Vzcda	Arming Voltage	Positive-going edge		2.1	_	V
Vzcdt	Triggering Voltage	Negative-going edge		1.6	_	V
Izcob	Input Bias Current	Vzcd =1 to 4.5V		2	_	μA
Izcosrc	Source Current Capability	_	-2.5	_	-10	mA
IZCDsnk	Sink Current Capability	_	3.0	_	_	mA
VzcDdis	Disable Threshold	_	150	200	250	mV
VzcDen	Restart Threshold	_	330	400	470	mV
IzcDres	Restart Current after Disable	Vzcd <vdis, vcc="">Vcc-off</vdis,>	-80	-120	_	μΑ
STARTER			•			
tstart	Start Timer Period	1-	75	130	300	μs
	1	1			1	

Notes:

<sup>6.</sup> All parameters are in tracking. 7. The multiplier output is given by: current sense comparator O/P,  $V_{CS} = k \, x \, (V_{COMP} - \ 2.5V) \, x \, V_{MULT}$ .



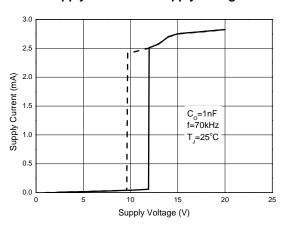
# **Electrical Characteristics** (continued)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
OUTPUT OVE	OUTPUT OVER-VOLTAGE					
lovp	Dynamic OVP Triggering Current	_	35	40	45	μA
VOVP_TH	Static OVP Threshold	_	2.1	2.25	2.4	V
CURRENT SENSE COMPARATOR						
lcs	Input Bias Current	V <sub>CS</sub> = 0	_	_	-1	μA
td(H-L)	Delay to Output	_	_	200	350	ns
V <sub>CS-clamp</sub>	Current Sense Clamp	V <sub>COMP</sub> = upper clamp	1.6	1.7	1.8	V
\/ ··	Current Sense Offset	VMULT = 0	_	30	_	mV
VCS-offset		V <sub>MULT</sub> = 2.5V	_	5	_ ]	
GATE DRIVE	र	•				
Vol	Output Low Dropout Voltage	IgDsink = 200 mA	_	0.9	1.9	V
	Output High Dropout Voltage	I <sub>GDsource</sub> = 200 mA		2.5	3.0	V
Vон		IgDsource = 20 mA		2.0	2.8	V
tf	Voltage Fall Time	_		30	70	ns
tr	Voltage Rise Time	_	-	60	110	ns
Voclamp	Output Clamp Voltage	ISOURCE = 5 mA, Vcc =20 V	9	11	13	V
Vos	UVLO Saturation	V <sub>CC</sub> =0 V to V <sub>CCon</sub> , I <sub>SINK</sub> = 10 mA	-		1.1	V

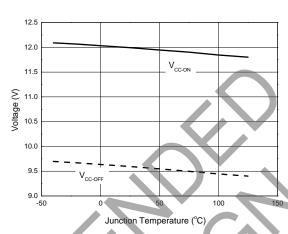


### **Performance Characteristics**

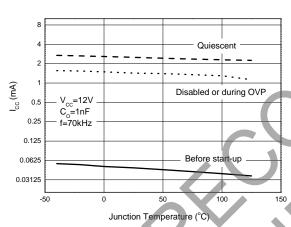
### Supply Current vs. Supply Voltage



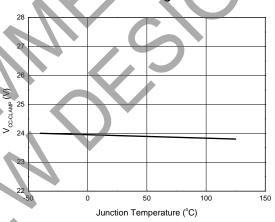
### Start-up & UVLO vs. $T_{\rm J}$



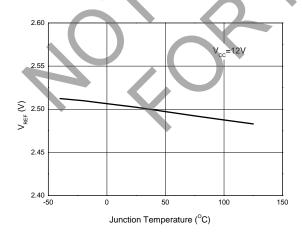
Icc Consumption vs.TJ



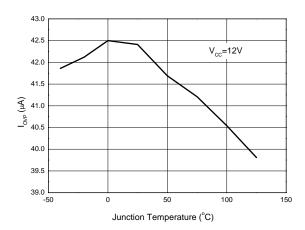
Vcc Zener Voltage vs. TJ



Feedback Reference Voltage vs. TJ



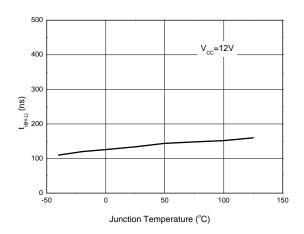
OVP Current vs. TJ



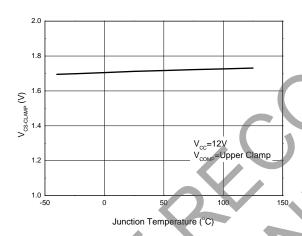


# **Performance Characteristics** (continued)

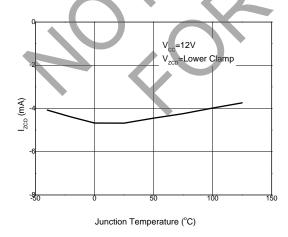
#### Delay-to-output vs.TJ



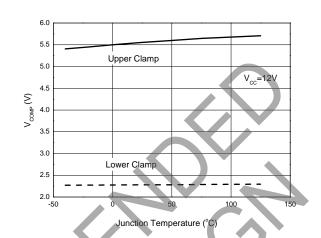
### $V_{\text{CS-CLAMP}}$ vs.T<sub>J</sub>



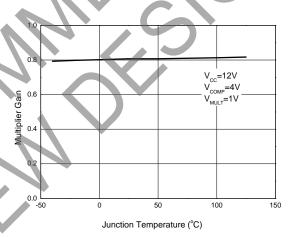
# ZCD Source Capability vs.TJ



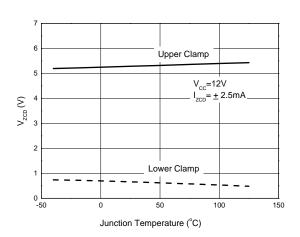
### E/A Output Clamp Levels Vs. TJ



# Multiplied Gain Vs. TJ



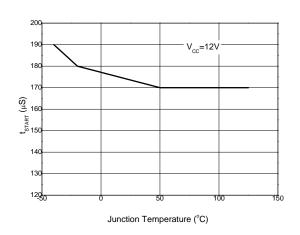
### ZCD Clamp Levels Vs. TJ



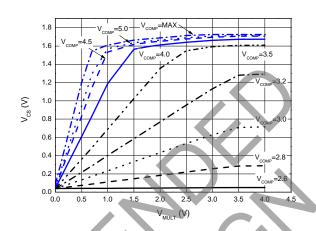


# **Performance Characteristics** (continued)

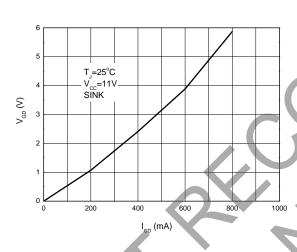
### Start-up Timer vs.TJ



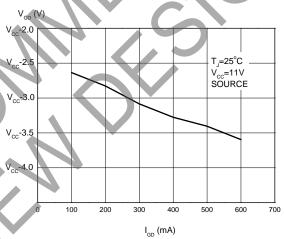
### **Multiplier Characteristics**



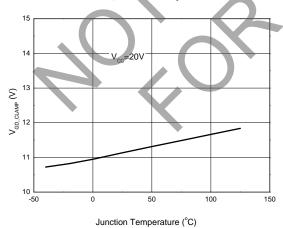
### **Gate-driver Output Low Saturation**



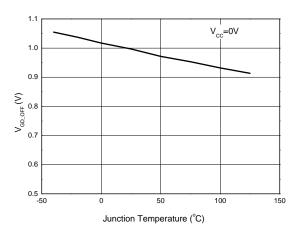
Gate-driver Output High Saturation



### Gate-driver Clamp vs. TJ



UVLO Saturation vs. TJ





# **Application Information**

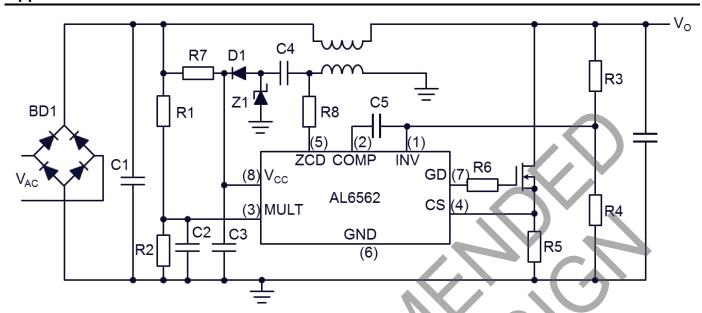


Figure 2. Boost Pre-Regulator PFC

#### **POWER FACTOR CORRECTION**

AL6562 functions as a transition mode PFC IC, meaning the MOSFET turns on when inductor current reaches zero, and turns off when the current meets desired input current reference voltage, as shown in Figure 3. A typical current waveform is depicted with envelope as shown, with the input current following that of the input voltage, achieving good power factor.

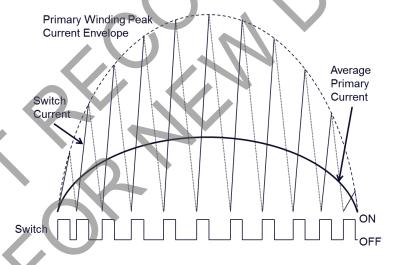


Figure 3. Typical Waveform of Inductor Current with Fixed ON Time

From a mathematical point of view, a PF value can be defined by:

$$PF = cos(\theta) * k_D = \frac{cos(\theta)}{\sqrt{1 + \sum_{2}^{\infty} \left(\frac{lrms_n}{l_rms_n}\right)^2}}$$

Where  $cos(\theta)$  represents displacement factor with  $\theta$  as the displacement angle between voltage and current fundamentals, and  $k_D$  represents distortion respectively.



 $k_{\rm D}$ , the distortion can further be defined by:

$$k_{D} \, = \frac{I_{rms\_1}}{I_{rms}} = \frac{I_{rms\_1}}{\sqrt{I_{rms\_2}^2 + \, I_{rms\_3}^2 + \, ...}}$$

Where  $I_{rms\_1}$  and  $I_{rms\_n}$  are the RMS (Root Mean Square) value n-th fundamental component of the current respectively. If the current and voltage are in phase, then  $\theta$ = 0, which will lead to  $\cos(\theta)$  = 1, and the PF will be simplified as:

$$PF = k_D$$

#### **ZCD (Zero Current Detection)**

The ZCD feature detects when the transformer primary current falls to zero, as the voltage across the inductor reverses, to initiate a new cycle that switches on the power MOSFET. The signal for ZCD is obtained by an auxiliary winding on the boost inductor, as shown in Figure 2.

#### Multiplier

The internal multiplier takes two inputs, one from a portion of the instantaneous rectified line voltage (via pin 3, MULT) and the other from the output of the E/A (via pin 2, COMP), to feed the PWM comparator to determine the exact instant when the MOSFET is to be switched off. The output of multiplier is a rectified sinusoid, similar to the instantaneous rectified line voltage, multiplied by the scaling factor determined by output of the Error Amplifier. The MULT output is then fed into the PWM comparator and is compared to the current sense voltage Vcs, to switch the Power MOSFET off. The formula governing all parameters is given by:

Multiplier Output:

$$V_{CS} = k x (V_{COMP} - 2.5V) x V_{MULT}$$

Where: k is the multiplier gain. VMULT is set by external resistors R1 and R2.

#### **OVP (Output Overvoltage Protection)**

The output voltage can be kept constant by the operation of the PFC circuit close to its nominal value, as shown by Figure 2, which is set by the ratio of the two external resistors R3 and R4. Neglecting ripple current, current flowing through R3, I<sub>R3</sub>, will equal the current through R4, I<sub>R4</sub>. As the non-inverting input of the error amplifier is biased inside the AL6562 at 2.5V, the current through R4 is:

$$I_{R4} = \frac{2.5}{R_4} = I_{R3} = \frac{V_0 - 2.5}{R_3}$$
 (1)

If any abrupt change of output voltage,  $\Delta V_0 > 0$  occurs due to a load drop, the voltage at pin INV will be kept at 2.5V by the local feedback of the EA. The network connected between INV and COMP introduces a time constant to achieve high PF. The current through R4 will remain equal to 2.5/R4, but I<sub>R3</sub> will become:

$$I'_{R3} = \frac{V_0 + \Delta V_0 - 2.5}{R_2} \tag{2}$$

The difference current  $\Delta I_{R3} = I'_{R3} - I_{R3} = \Delta V_0/R3$  will flow through the compensation network and enter the error amplifier output via pin COMP. The AL6562 monitors the current flowing into the error amplifier output pin. When the detected current is higher than 40µA, the dynamic OVP is triggered. The IC will be disabled and the driver signal will be stopped.

The output  $\Delta Vo$  that is able to trigger the Dynamic OVP function is then:

$$\Delta V_{\rm O} = 40 \text{uA} \times \text{R3} \tag{3}$$



On the other hand, when the loading of PFC pre-regulator becomes low, the output voltage tends to stay steadily above the nominal value, which is not the case when OVP is triggered by abrupt voltage increase. If this occurs, the E/A will saturate low, the external power transistor is switched OFF, and the IC is put in idle state (static OVP). Normal operation is resumed as the error amplifier goes back into its linear region. As a result, the device will work in burst-mode, with a repetition rate that can be very low. When either OVP is activated, the quiescent consumption of the IC is reduced to minimum by the discharge of the capacitor and increases the hold-up capability of the IC supply.

#### **THD (Total Harmonics Distortion)**

The AL6562 reduces the THD by reducing conduction dead-angle occurring to the AC input current near the zero-crossings of the line voltage.

The important reason for this distortion to take place is the inability of the system to transfer energy effectively when the instantaneous line voltage is very low, which is the case near line-voltage zero-crossing. This effect is magnified by the high-frequency filter capacitor placed after the bridge rectifier, which retains some residual voltage that causes the diodes of the bridge rectifier to be reverse-biased and the input current flow to temporarily stop.

To overcome this issue, the circuit section designed in the AL6562 forces the PFC regulator to process more energy near the line voltage zero-crossings, as compared to that commanded by the control loop. This results in both minimizing the time interval when energy transfer is lacking, and fully discharging the high-frequency filter capacitor after the bridge.

In essence, the circuit artificially increases the ON-Time of the Power Switch with a positive offset added to the output of the multiplier in the proximity of the line voltage zero-crossings. This offset is reduced as the instantaneous line voltage increases, so that it becomes negligible as the line voltage moves towards the peak of the sinusoidal waveform.

Therefore, to maximize the benefit from the THD improvement circuit, the high-frequency filter capacitor after the bridge rectifier should be minimized and kept to satisfy the EMI filtering requirements.

#### Non-Latched IC Disable (Enable)

Pin 1, INV, inverting input to the error amplifier, can be adapted to disable the system when the voltage on this pin is below 0.2V. In order to restart the system, a voltage exceeding 0.45V must be applied. The ON/OFF control signal can be driven by a PWM controller and using an NPN transistor to pin 1 to shut it down.





### Single Stage LED Driver with PFC

One of the major applications of AL6562 is to provide a single stage power module with high PF for LED lighting. The following circuit, Figure 4, shows a simplified fly-back AC-DC converter with both CC and CV feedback from output side, to prevent overload and also provide an overvoltage protection facility.

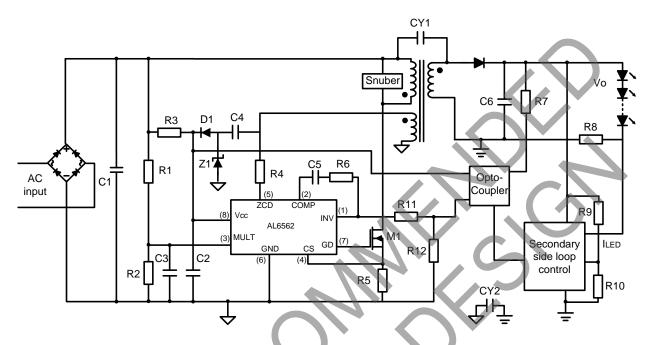


Figure 4. Single Stage PFC Isolated LED lighting

With its high performance, the AL6562 offers the following advantages that make this solution an appropriate method against the traditional PWM controller, where a good PF value is required:

- The input capacitance can be reduced to replace a bulky and expensive high-voltage electrolytic capacitor (as required by regular offline SMPS) by a small-size, cheaper film capacitor.
- Transition mode ensures low turn-on losses in MOSFET and higher efficiency can be achieved.
- Lower parts count means lower material cost, as well as lower assembly cost for limited space.



#### **PFC Pre-Regulator**

Another major application of AL6562 is to implement a wide-range mains input PFC pre-regulator, which acts as the input stage for the cascaded DC-DC converter and can deliver above 350W in general.

There are two methods, in general, to design a pre-regulator stage:

- With fixed frequency or
- 2. With fixed ON time

The AL6562 can easily be implemented with fixed ON time due to its simplicity, while the fixed frequency technique is more complicated.

In fixed ON time mode, AL6562 is also working in transition mode where the inductor current will be turned on when zero crossing is detected.

By using boost-switching technique, the AL6562 shapes the input current by drawing a quasi-sinusoidal current in-phase with the line voltage. A simplified circuit, shown in Figure 5, explains the operation as follows:

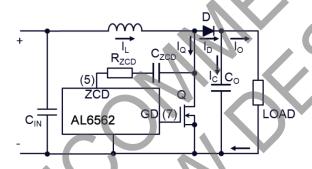


Figure 5. ZCD Pin Synchronization without Auxiliary Winding

The AC mains voltage is rectified by a diode bridge and delivered to the boost converter which boosts the rectified input voltage to a higher regulated DC bus V<sub>O</sub>.

The error amplifier compares a portion of the output voltage with an internal reference and generates a signal error proportional to the difference between them. The bandwidth of the internal error amplifier is set to be narrow within 20Hz; the output would be a DC value over a given half-cycle. Output of E/A fed into multiplier, multiplied by a portion of the rectified mains voltage, will generate a scaled rectified sinusoid whose peak amplitude depends on the rectified mains peak voltage as well as the value of error signal.

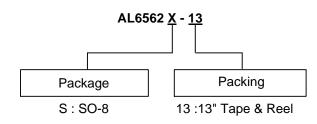
The output of the multiplier is fed into the non-inverting pin of the internal PWM comparator. As the output from the multiplier, a sinusoidal reference for PWM, equals the voltage on the current sense pin CS(4), the MOSFET will be turned off. As a consequence, the peak inductor current will follow the envelope of a rectified sinusoid. After the MOSFET is turned off, the boost inductor discharges its stored energy to the load until zero current is detected and then the MOSFET will be turned on again.

In the case where there is no auxiliary winding on the boost inductor, a solution can be implemented by connecting the ZCD pin to the drain of the power MOSFET through an R-C network: in this way the high-frequency edges experienced by the drain will be transferred to the ZCD pin, hence arming and triggering the ZCD comparator.

The resistance value must be properly chosen to limit the current sourced/sunk by the ZCD pin. In typical applications with output voltages around 400V, recommended values for these components are 22pF (or 33pF) for  $C_{ZCD}$  and 330K for  $R_{ZCD}$ . With these values proper operation is ensured even with a few volts difference between the regulated output voltage and the peak input voltage.



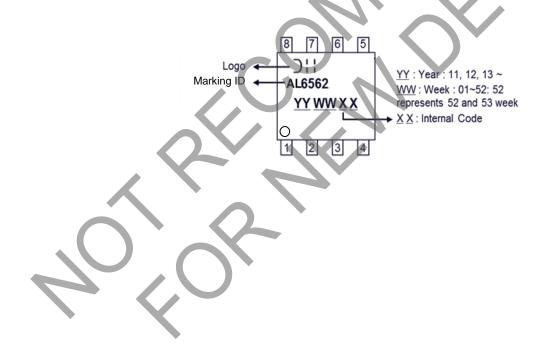
# **Ordering Information**



Bert Nerreleen	Dl	Darles es de	13" Tape and Reel		
Part Number	Package	Package code	Quantity	Part Number Suffix	
AL6562S-13	SO-8	S	2,500/Tape & Reel	-13	

# **Marking Information**

### (1) SO-8

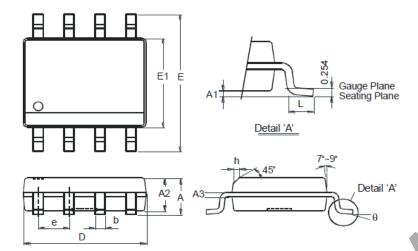




# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### **SO-8**

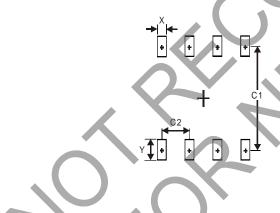


SO-8			
Dim Min		Max	
Α	-	1.75	
A1	0.10	0.20	
A2	1.30	1.50	
A3	0.15	0.25	
b	0.3	0.5	
D	4.85	4.95	
E	5.90	6.10	
E1	<b>E1</b> 3.85 3.95		
е	1.27	Тур	
h		0.35	
L	L 0.62 0.82		
θ	0°	8°	
All Dimensions in mm			

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.





Dimensions	Value (in mm)
Х	0.60
Y	1.55
C1	5.4
C2	1 27



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